Ceramic

High Pass Filter

HFCW-5000+

50Ω 5500 to 20000 MHz

Generic photo used for illustration purposes only
CASE STYLE: JC0603C

The Big Deal

- Very good rejection, 45 dB typical
- Small size 0603 (0.063" X 0.032" X 0.024")
- Good Power handling, 1.75W
- Ceramic construction

Product Overview

HFCW-5000+ is a high pass filter with passband from 5500 MHz to 20000 MHz supporting a variety of applications. This model provides good insertion loss over a wide band due to strategically constructed layout. Housed in a tiny 0603 ceramic form factor with wraparound terminations, the filter is ideal for dense PCB layouts with minimal performance variation due to parasitics.

Key Features

Feature	Advantages
Small size, 0603 (0.063" X 0.032" X 0.024")	Accommodates tight space requirements for dense PCB layouts.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.
Ultra-wide pass band	This filter has a very wide passband from 5.5 GHz to 20 GHz.

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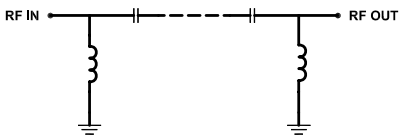
+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Features
- Very good rejection, 45 dB typ.
- Small size 0603 (0.063" X 0.032" X 0.024")
- Temperature stable
- LTCC construction

Applications
- Test and measurements
- Military applications
- Telecommunications and broadband wireless systems

Functional Schematic



Electrical Specifications[1,2] at 25°C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Stop Band	Rejection Loss	DC-F1	DC - 3000	39	45	-	dB
		F1-F2	3000 - 4000	20	40	-	dB
	Freq. Cut-Off	F3	5000	-	3.0	-	dB
Pass Band	Insertion Loss	F4-F5	5500 - 7000	-	2.2	-	dB
		F5-F6	7000 - 13500	-	0.9	1.4	dB
		F6-F7	13500 - 20000	-	2.0	-	dB
	Return Loss	F4-F7	5500 - 20000	-	9	-	dB

1 This component is not intended to act as a DC block. Please consult with Mini-Circuits for further details
2 Measured on Mini-Circuits Characterization Test Board TB-HFCW-5000+

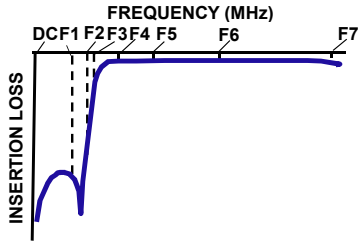
Maximum Ratings	
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input*	1.75W @ 25°C

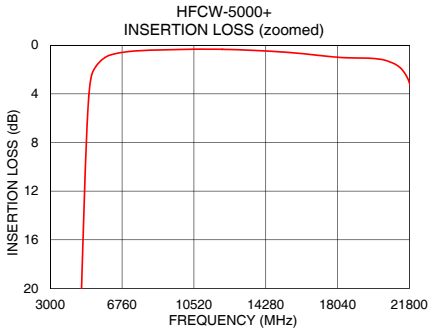
* Passband rating, derate linearly to 0.5W at 125°C ambient
Permanent damage may occur if any of these limits are exceeded.

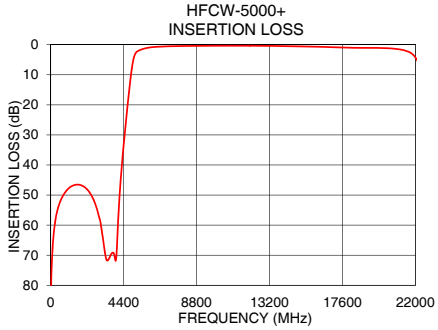
Typical Performance Data at 25°C

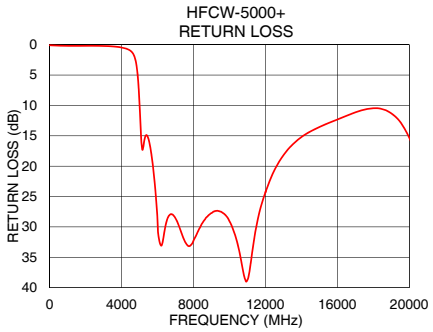
Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	82.88	0.08
100	68.86	0.10
500	53.21	0.15
1000	48.20	0.18
2000	47.21	0.18
3000	58.91	0.20
3500	71.26	0.28
4000	66.10	0.45
4450	30.12	0.90
4630	20.28	1.42
4840	9.93	3.56
5000	4.53	9.72
5500	1.52	15.55
6000	0.89	28.99
7000	0.54	28.57
10000	0.35	29.07
13500	0.42	16.47
15000	0.54	13.55
18000	0.98	10.46
20000	1.10	15.36

Typical Frequency Response









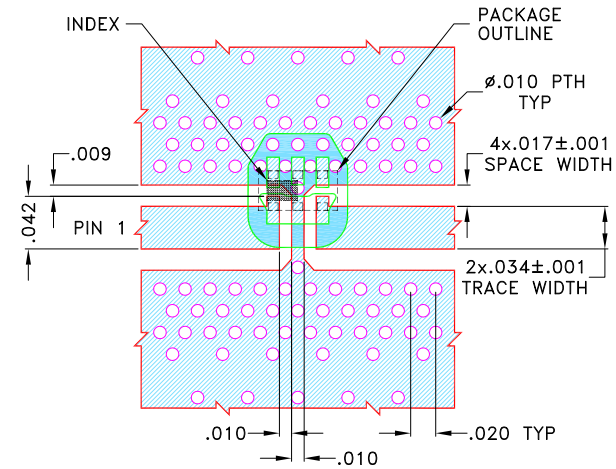
Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

INPUT	1
OUTPUT	3
GROUND	2,4,5,6

Product Marking: 3

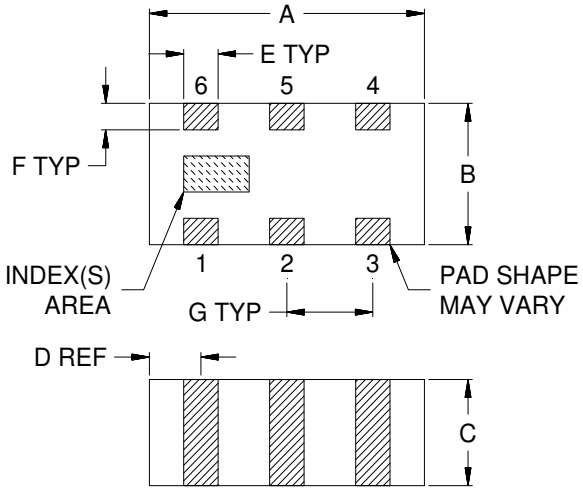
Demo Board MCL P/N: TB-HFCW-5000+
Suggested PCB Layout (PL-703)



NOTES:
1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .0200±.0015. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)
DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

Outline Drawing



Outline Dimensions (inch / mm)

A	B	C	D	E	F	G	Wt.
.063	**.032**	**.024**	**.012**	**.008**	**.006**	**.020**	grams
1.60	0.80	0.60	0.30	0.20	0.15	0.50	.005

Note: Please refer to case style drawing for details.

Ceramic High Pass Filter HFCW-5000+

Typical Performance Data

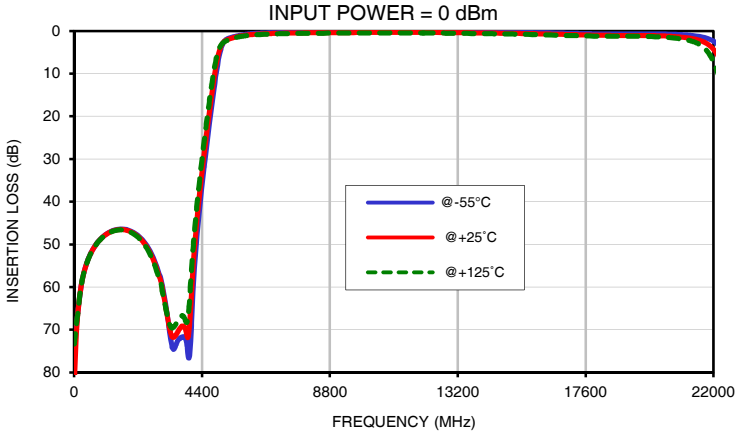
FREQ. (MHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)			OUTPUT RETURN LOSS (dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
10	76.20	82.88	73.33	0.06	0.08	0.10	0.05	0.08	0.09
100	67.95	68.86	67.56	0.07	0.10	0.12	0.06	0.09	0.11
300	57.64	57.63	57.65	0.10	0.13	0.16	0.09	0.12	0.15
500	53.18	53.21	53.23	0.12	0.15	0.19	0.11	0.15	0.18
700	50.54	50.58	50.62	0.13	0.17	0.22	0.11	0.16	0.20
900	48.80	48.84	48.88	0.13	0.18	0.23	0.12	0.17	0.22
1100	47.62	47.67	47.72	0.13	0.18	0.24	0.12	0.18	0.22
1300	46.87	46.94	47.00	0.13	0.19	0.24	0.11	0.18	0.22
1500	46.49	46.57	46.65	0.12	0.19	0.24	0.11	0.18	0.22
1700	46.43	46.55	46.66	0.11	0.18	0.24	0.10	0.18	0.23
1900	46.74	46.91	47.04	0.10	0.18	0.24	0.10	0.18	0.23
2100	47.44	47.61	47.79	0.10	0.18	0.24	0.09	0.18	0.23
2300	48.59	48.81	49.05	0.09	0.18	0.24	0.09	0.18	0.24
2500	50.28	50.61	50.92	0.08	0.18	0.25	0.09	0.19	0.25
2700	52.75	53.20	53.61	0.08	0.19	0.26	0.09	0.19	0.27
2900	56.42	56.99	57.51	0.08	0.20	0.27	0.09	0.20	0.28
3000	58.31	58.91	59.47	0.09	0.20	0.28	0.10	0.21	0.29
3200	66.23	66.55	66.51	0.10	0.22	0.31	0.11	0.23	0.32
3400	74.48	71.76	69.51	0.12	0.26	0.35	0.13	0.27	0.37
3600	72.28	70.11	67.54	0.15	0.30	0.41	0.16	0.31	0.43
3800	71.76	69.41	67.34	0.20	0.36	0.49	0.21	0.38	0.52
4000	73.93	66.10	60.03	0.27	0.45	0.60	0.28	0.47	0.64
4450	33.18	30.12	27.28	0.60	0.90	1.21	0.60	0.95	1.32
4630	23.11	20.28	17.67	0.95	1.42	1.98	0.95	1.51	2.20
4840	12.26	9.93	8.10	2.26	3.56	5.35	2.26	3.83	6.09
5000	5.60	4.53	4.00	6.42	9.72	12.86	6.46	10.94	16.58
5090	3.39	3.08	3.01	12.17	15.34	16.44	12.32	18.58	20.96
5500	1.34	1.52	1.64	14.36	15.55	17.44	13.95	15.02	16.56
5900	0.79	0.98	1.11	21.00	24.67	29.08	19.68	22.35	24.96
6300	0.54	0.74	0.87	30.53	32.27	32.65	27.94	29.27	30.56
6700	0.42	0.61	0.73	27.22	27.96	30.65	28.11	28.66	32.00
7000	0.36	0.54	0.66	27.07	28.57	32.68	28.34	29.93	35.63
7400	0.30	0.48	0.59	28.87	31.55	34.89	30.75	34.27	38.90
7800	0.26	0.44	0.55	31.48	33.14	32.59	33.62	35.57	32.96
8200	0.23	0.41	0.52	32.50	31.07	29.80	33.31	31.39	29.26
8600	0.21	0.40	0.51	31.22	28.90	28.20	31.01	28.59	27.48
9000	0.19	0.38	0.49	30.43	27.73	27.26	29.55	27.33	26.69
9400	0.17	0.36	0.48	30.27	27.40	27.07	29.47	27.11	26.84
9800	0.15	0.35	0.46	30.79	28.12	27.61	30.02	28.08	27.68
10200	0.13	0.34	0.45	32.81	30.42	29.28	32.03	30.84	29.88
10600	0.13	0.32	0.44	38.27	34.76	32.81	38.07	37.09	34.89
11000	0.12	0.32	0.44	45.90	38.71	38.10	43.28	49.43	50.06
11400	0.12	0.33	0.45	33.43	31.46	32.18	32.81	31.75	32.74
11800	0.12	0.33	0.45	27.86	26.11	26.06	27.38	26.11	26.12
12200	0.12	0.35	0.47	24.15	22.71	22.26	23.73	22.58	22.21
12600	0.12	0.36	0.49	21.23	20.09	19.48	21.11	20.12	19.57
13000	0.14	0.38	0.52	19.03	18.20	17.59	19.11	18.35	17.76
13500	0.17	0.42	0.57	16.98	16.47	15.96	17.14	16.67	16.16
14000	0.20	0.45	0.61	15.43	15.20	14.80	15.71	15.49	15.10
14500	0.24	0.49	0.66	14.34	14.29	14.00	14.60	14.55	14.26
15000	0.28	0.54	0.71	13.49	13.55	13.31	13.68	13.78	13.52
15500	0.33	0.60	0.78	12.78	12.91	12.60	12.91	13.08	12.74
16000	0.38	0.66	0.86	12.24	12.32	11.91	12.27	12.39	11.94
16500	0.44	0.74	0.96	11.58	11.71	11.20	11.56	11.73	11.18
17000	0.52	0.83	1.06	10.97	11.14	10.66	10.97	11.14	10.63
17500	0.60	0.91	1.14	10.43	10.68	10.33	10.42	10.68	10.31
18000	0.67	0.98	1.20	10.15	10.46	10.38	10.17	10.49	10.41
18500	0.71	1.03	1.22	10.20	10.61	10.87	10.30	10.71	11.02
19000	0.72	1.05	1.23	10.72	11.32	11.98	10.88	11.55	12.35
20000	0.70	1.10	1.34	14.51	15.36	16.73	15.24	16.67	19.01

Typical Performance Data

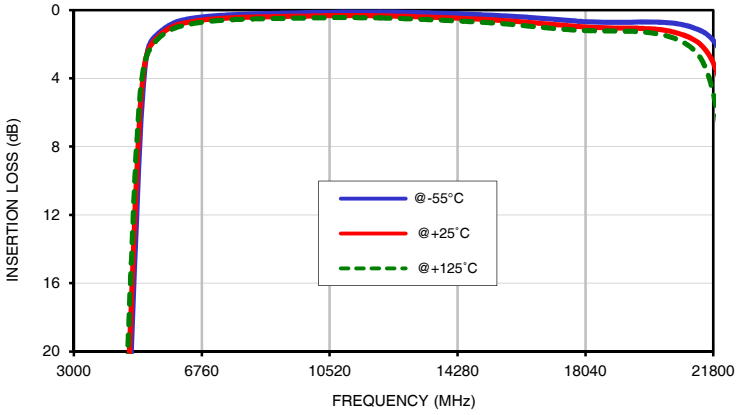
FREQ. (MHz)	GROUP DELAY (nsec)		
	@-55°C	@+25°C	@+125°C
5500	0.39	0.37	0.35
5800	0.29	0.28	0.27
6100	0.23	0.22	0.21
6400	0.19	0.18	0.18
6700	0.16	0.16	0.15
7000	0.14	0.14	0.13
7300	0.12	0.12	0.12
7600	0.11	0.11	0.11
7900	0.10	0.10	0.10
8200	0.09	0.09	0.09
8500	0.08	0.08	0.08
8800	0.08	0.08	0.08
9100	0.08	0.07	0.07
9400	0.07	0.07	0.07
9700	0.07	0.07	0.07
10000	0.06	0.06	0.07
10300	0.06	0.06	0.06
10600	0.06	0.06	0.06
10900	0.06	0.06	0.06
11200	0.06	0.06	0.06
11500	0.06	0.06	0.06
11800	0.05	0.06	0.06
12100	0.05	0.05	0.06
12500	0.05	0.05	0.05
12800	0.05	0.05	0.05
13100	0.05	0.05	0.05
13500	0.05	0.05	0.05
14000	0.05	0.05	0.05
14500	0.05	0.05	0.05
15000	0.05	0.05	0.05
15500	0.05	0.05	0.05
16000	0.05	0.05	0.06
16500	0.05	0.05	0.06
17000	0.05	0.06	0.06
17500	0.06	0.06	0.06
18000	0.06	0.06	0.06
18500	0.06	0.06	0.07
19000	0.06	0.07	0.07
19500	0.07	0.08	0.08
20000	0.08	0.08	0.09

Typical Performance Curves

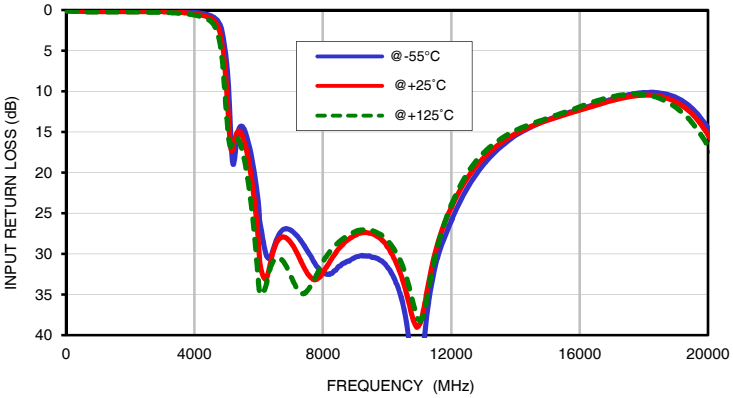
INSERTION LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



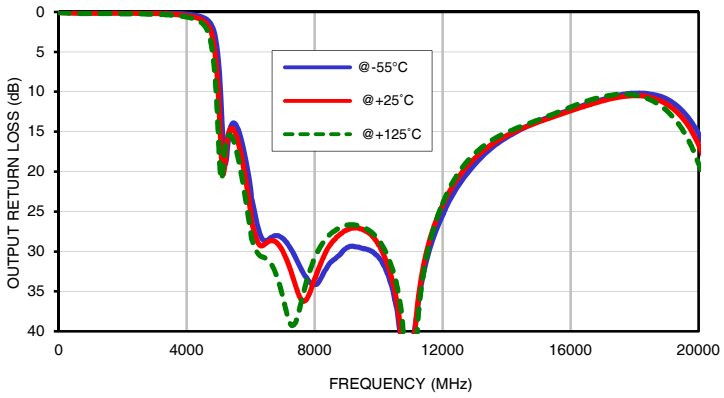
INSERTION LOSS vs. TEMPERATURE (Zoomed)
INPUT POWER = 0 dBm



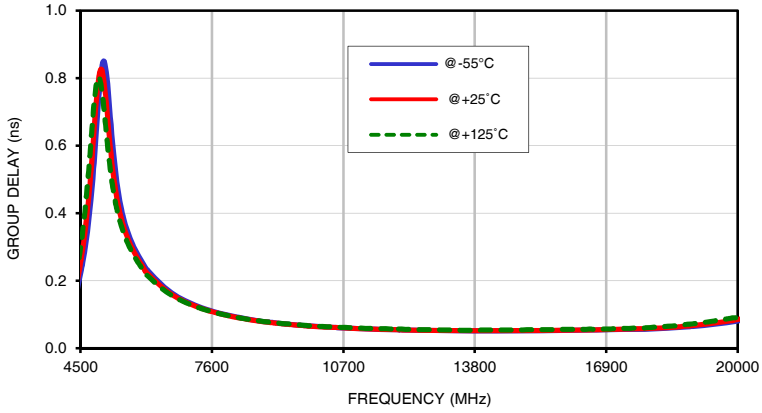
INPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm



OUTPUT RETURN LOSS vs. TEMPERATURE
INPUT POWER = 0 dBm

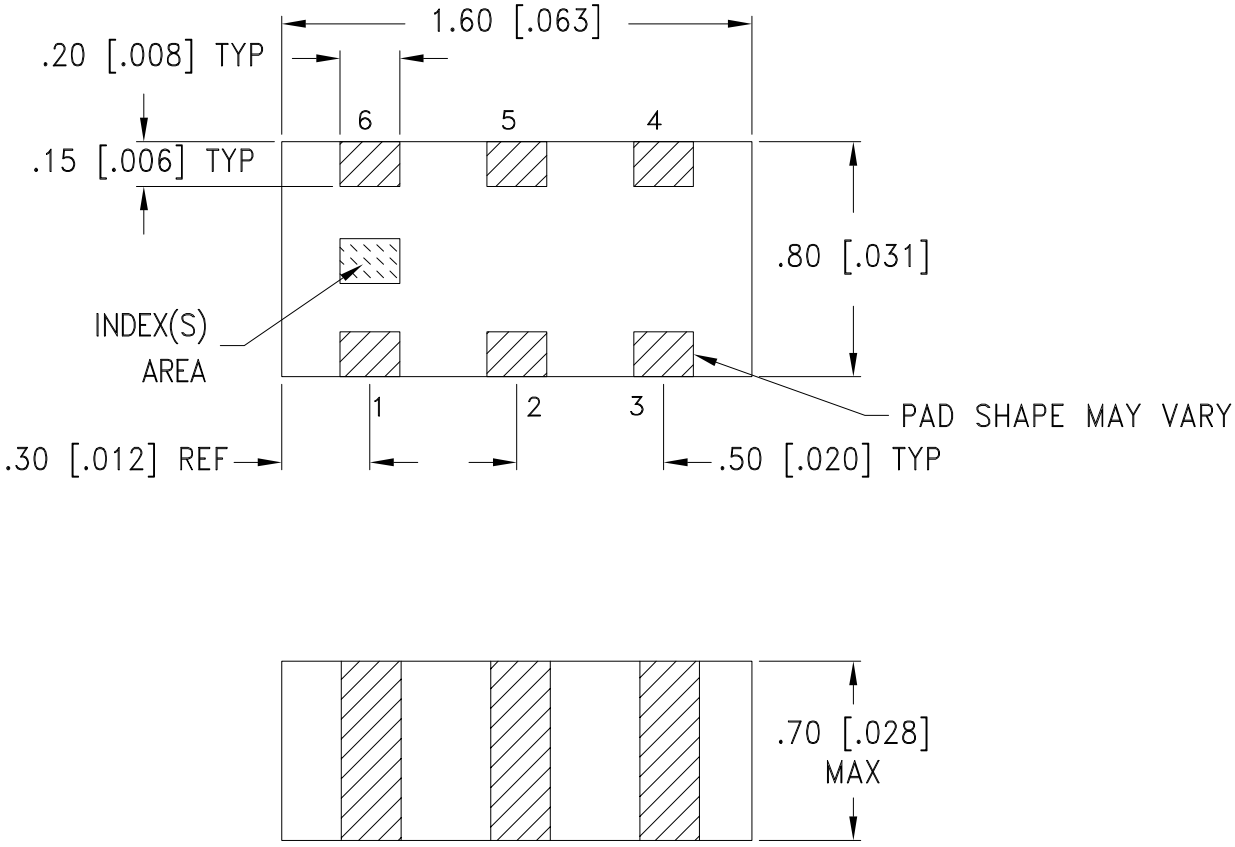


GROUP DELAY vs. TEMPERATURE
INPUT POWER = 0 dBm



Case Style JC

Outline Dimensions JC0603C



METALLIZATION

Weight: .005 grams

Dimensions are in mm [inch]. Tolerances: ±0.13 mm

Notes:

1. Open style, ceramic base.
2. Termination finish:
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

Tape & Reel Packaging TR-F114

DEVICE ORIENTATION IN T&R

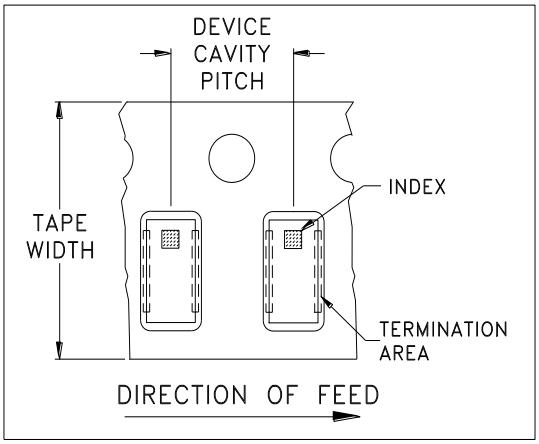


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

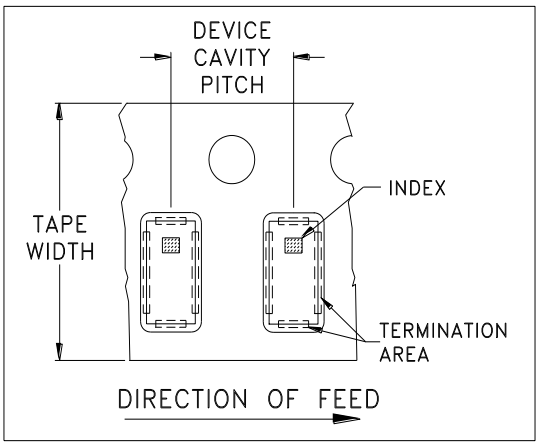


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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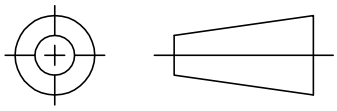
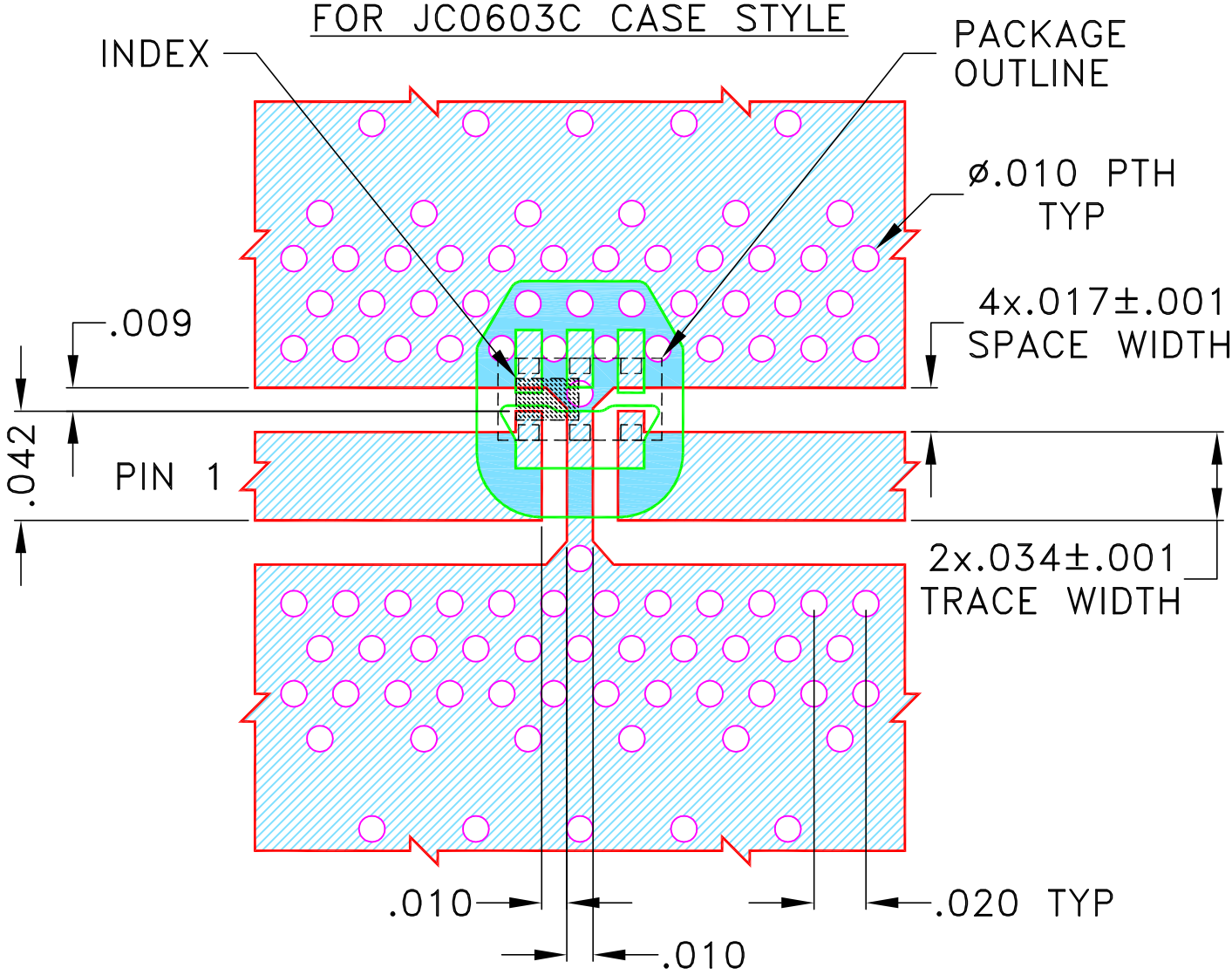
THIRD ANGLE PROJECTION



REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-006344	NEW RELEASE	FEB 21	DDR	VC

SUGGESTED MOUNTING CONFIGURATION FOR JC0603C CASE STYLE



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2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

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DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	DDR	17 FEB 21
TOLERANCES ON:	CHECKED	RV	17 FEB 21
2 PL DECIMALS ±	APPROVED	RKS	17 FEB 21
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

Mini-Circuits®
13 Neptune Avenue
Brooklyn NY 11235

PL DWG, JC0603C C.S, 50 OHM, HFCW

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-703	OR
FILE: 98PL703		SCALE: 15:1	SHEET: 1 OF 1

Mini-Circuits

Environmental Specifications ENV126

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A